



IFW

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the application of)
RAVKIN et al.)
Application No: 10/607,611)
Filed: June 27, 2003)
For: APPARATUS AND METHOD FOR)
DEPOSITING AND PLANARIZING THIN)
FILMS OF SEMICONDUCTOR WAFERS)

Examiner: Unassigned
Art Unit: 2812
Docket No: LAM2P428
Date: May 19, 2004

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on May 19, 2004.

Signed: _____

Kay Harlow

**REQUEST TO RESCIND PREVIOUS NONPUBLICATION REQUEST &
NOTICE OF FOREIGN FILING**

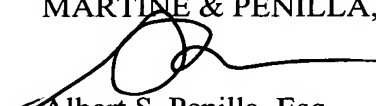
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

A request that the above-identified application not be published under 35 U.S.C. 122(b) (non-publication request) was included with the above-identified application on filing pursuant to 35 U.S.C. 122(b)(2)(B)(i).

I hereby **RESCIND** the previous non-publication request. If a **notice** of foreign or international filing is or will be required by 35 U.S.C. 122(b)(2)(B)(iii) and 37 CFR 1.213(c), I hereby provide such **NOTICE**. This notice is being provided no later than forty-five (45) days after the date of such foreign or international filing.

Respectfully submitted,
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Attorney Docket No. LAM2P428